(check

Declaration for Patent Application



As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled <u>Cutting Device For Separating Individual Laminated Chip Assemblies From A Strip Thereof, Method Of Separation And A Method Of Making The Cutting Device the specification of which</u>

one)				
1			as Applica s amended	ation Serial on

[] is attached hereto.

(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by an amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, \$119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

			Priority <u>Claimed</u>	
(Number)	(Country)	(Day/Month/Year Filed)	[] Yes	[] No
(Number)	(Country)	(Day/Month/Year Filed)	[] Yes	[] No
(Number)	(Country)	(Day/Month/Year Filed)	[] Yes	[] No

I hereby claim the benefit under Title 35, United States Code, \$120 of an United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, \$112, I acknowledge the duty to

disclose material information as defined in Title 31, code of Federal Regulations, \$1.56 (a) which occurred between the filing of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
be true; and further that the	s made on informati hese statements wer ts and the like so nder Section 1001 o illful false statem	on and belief are believed to made with the knowledge made are punishable by fine of Title 18 of the United ments may jeopardize the
I hereby appoint the follows this application and to transfice connected therewith: Bennett, Reg. No. 28,821; Vol. 2005, Reg. No. 40,970.	nsact all business Marv E. Porter, R	in the Patent and Trademark Reg. No. 33,440; David
address all telephone calls at telephone no. (508) 795	to Mary E. Porter -2555	
Address all correspondence New Bond Street, Box 15138,	to Mary E. Porter, Worcester, Massach	SAINT-GOBAIN CORPORATION, 1 usetts 01615-0138
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